

**Section**

MV Semi-conductor

**Application**Field  
Laboratory  
Production**PRODUCT BENEFITS**Fine tuning of the scoring depth  
Chamfer on the transition**TOOL CAPACITY**

<b>Diameter</b>	14 - 50 mm 0,551 - 1,969 inch
<b>Max scoring depth</b>	1,4mm / 0,055 in
<b>Remaining length of semicon</b>	10 mm / 0,394 in

**TOOL DIMENSIONS**

<b>Length</b>	150 mm
<b>Width</b>	80 mm
<b>Height</b>	48 mm
<b>Weight without box</b>	0,695 Kg
<b>Packaging</b>	Box

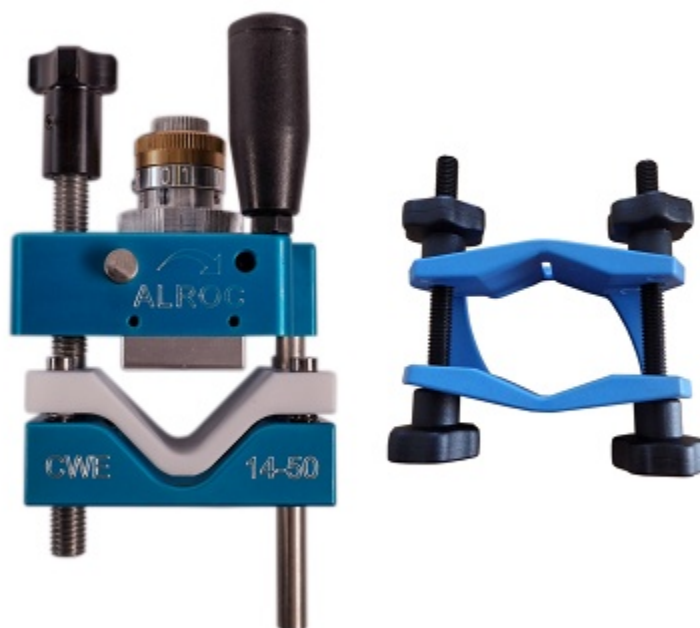
**ALROC SAS**Z.I. de la Fonderie - 72160 TUFFE  
FRANCE  
Phone: +33 2 43 71 11 80  
Fax number : +33 2 43 71 16 51  
www.alroc.fr**Tool to remove peelable semiconductor and stop for MV cable****TO DO WHAT**

The CWE/14-50-MVS enables the user to score the peelable semiconductor, in order to remove it.

It performs a chamfer on the semicon cutback.

Its design enables to make circular, longitudinal and helicoidal cuts.

The MVS sits on the cable to stop the CWE/14-50 with a large contact surface.

**Spare part**

MVS - Stop for tools

LS-CD6 - Spare blade for semiconductor scoring with chamfer

**Associated tool**

CWB/18-60-MVS - Remove bonded semiconductor with chamfer on the semiconductor cutback and stop

BRMRD1E - Tool to remove insulation

MV cables Tools

# CWE/14-50-MVS



Part Number	Diameter	Tool capacity		Dimensions			Packaging
		Max scoring depth	Remaining length of semicon	Length	Width	Height	
CWE/14-50-MVS	14 - 50 mm 0,551 - 1,969 in	1,4mm / 0,055 in	10 mm / 0,394 in	150 mm 5,906 in	80 mm 3,150 in	48 mm 1,890 in	box